



November 25, 2022

To All Parties Concerned

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Company Name: Hulic Co., Ltd.  
(TSE Prime Market, securities code 3003)

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**Notice regarding early redemption of  
subordinated bonds issued in Japan through public offering**

TOKYO, November 25, 2022 — Hulic Co., Ltd. ( “Hulic” or the “Company” ) hereby announces that it has determined to redeem all of its publicly offered 1st series unsecured subordinated bonds with optional interest deferral and early redemption clauses (the “Hybrid Bonds”) on January 26, 2023 which is the first discretionary early redemption date as follows.

	1st series unsecured subordinated bonds with optional interest deferral and early redemption clauses
(1) Total amount issued	JPY 50Bn
(2) Issue date	January 26, 2018
(3) Maturity date	January 26, 2053
(4) Early redemption	January 26, 2023 (The 1st discretionary redemption date)
(5) Initial interest rate	0.99% per annum
(6) Total early redemption amount	JPY 50Bn
(7) Amount of early redemption per bond	JPY 100 for each Hybrid Bond

**Note:**

The purpose of this news release is to make a general public announcement concerning the Hybrid Bonds by Hulic Co., Ltd. issued through public offering in Japan. It has not been prepared for the purpose of offer of, or solicitation of an offer to buy or subscribe for, securities of Hulic Co., Ltd.